

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

Assignment ID: PATI350864

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	Molex Japan LLC	07/08/2024
RECEIVING PARTY DATA		
Company Name:	Molex, LLC	
Street Address:	2222 Wellington court	
City:	lisle	
State/Country:	ILLINOIS	
Postal Code:	60532	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	13378003	
CORRESPONDENCE DATA		
Fax Number:		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Phone:	630-718-5534	
Email:	Paralegal_koch@CPAGlobal.com	
Correspondent Name:	Molex, LLC	
Address Line 1:	2222 Wellington court	
Address Line 4:	lisle, ILLINOIS 60532	
ATTORNEY DOCKET NUMBER:	MX-2009-P-0021-US-PCT	
NAME OF SUBMITTER:	Mahika Singh	
SIGNATURE:	Mahika Singh	
DATE SIGNED:	07/10/2024	
Total Attachments: 2		
source=MX-2009-P-0021-US-PCT_Molex JP to Molex LLC#page1.tiff		
source=MX-2009-P-0021-US-PCT_Molex JP to Molex LLC#page2.tiff		

ASSIGNMENT

WHEREAS, Molex Japan LLC, a limited liability company having a place of business at 1-5-4 Fukami-Higashi, Yamato, Kanagawa, 242-8585, JP ("Assignor"), owns or owned an interest in an invention entitled "**EDGE CONNECTOR**", for which U.S. Patent Application No. **13/378,003** was filed on **December 13, 2011 (MX-2009-P-0021-US-PCT)**; and

WHEREAS, Molex, LLC, a limited liability company having a place of business at 2222 Wellington Court, Lisle, Illinois 60532 ("Assignee"), desires acquiring or has acquired Assignor's interest in the above-identified inventions, the Application, and any related U.S. or foreign patent applications and patents;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged:

Assignor hereby authorizes Assignee to file any of the above-referenced patent applications in the name of Assignee, and Assignor authorizes and requests the patent office of any country to issue any patent granted from any of the above-referenced patent applications in the name of Assignee;

Assignor by this Assignment does hereby sell, assign, and transfer, or by virtue of employment or applicable agreements has sold, assigned, and transferred, to Assignee, Assignor's entire right, title, and interest in and to the above-identified inventions and all improvements and modifications to the above-identified inventions, the Application, any U.S. or foreign patent applications related to the above-identified inventions, any U.S. or foreign patent applications claiming priority to any of the above-referenced patent applications, including any nonprovisional, divisional, continuation, continuation-in-part, reexamination, reissue, extension, substitution, or renewal of any of the above-referenced patent applications, any right to claim priority arising from or required for any of the above-referenced patent applications under any applicable convention, treaty, statute, or regulation, any other right, privilege, or form of protection related to the above-identified inventions or any of the above-referenced patent applications, and any U.S. or foreign patent granted from any of the above-referenced patent applications, to the full end of the term of the patent, to be held and enjoyed by Assignee as fully and entirely as it would have been held and enjoyed by Assignor, including the right to pursue, collect, and retain damages and any other remedies arising from any past, present, or future infringement of patents granted from the above-referenced patent applications;

Assignor hereby warrants and covenants that Assignor has not and will not execute any assignment or other instrument in conflict with this Assignment;

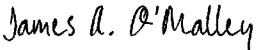
Assignor hereby covenants and agrees to perform any reasonable act that may be necessary or desirable to aid Assignee, its successors, legal representatives, and assigns, to obtain, maintain, and enforce protection in the U.S. and foreign countries for the above-identified inventions, above-referenced patent applications, and patents granted therefrom, including signing lawful papers, executing patent applications, making assignments, rightful oaths, and declarations, and testifying in judicial or administrative proceedings; and

Assignor and Assignee agree that this Assignment may be electronically signed, and that the electronic signatures appearing on this Assignment are the same as handwritten signatures for the purposes of validity, enforceability, and admissibility.


/ _____ /
Jae Hoon Lee, Authorized Signatory on behalf of
Assignor: Molex Japan LLC
Date: 2024-07-08

DECLARATION OF ACCEPTANCE

Assignee hereby acknowledges and accepts the aforementioned assignment of right, title, and interest and confirms consent that this Assignment may be recorded in appropriate patent offices.

DocuSigned by:

/ _____ /
James A. O'Malley, Authorized Signatory on behalf of
Assignee: Molex, LLC
Date: 2024-07-08